TOSHIBA RF Power Amplifire Module

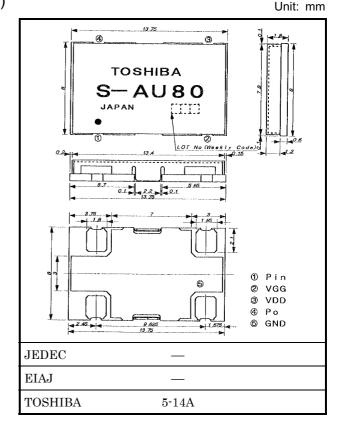
S-AU80

900 MHz Band Amplifier Applications (GSM)

Output Power: P₀ = 35.0 dBmW (typ.)

• Power Gain: Gp = 35.0 dB (typ.)

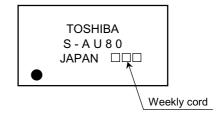
• Total Efficiency: $\eta T = 43\%$ (typ.)



Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit	
DC Supply Voltage	V_{DD}	8 (Note1)	V	
DC Supply Voltage	V_{GG}	5 (Note2)	V	
DC Current	I _{DD}	5	Α	
Input Power	Pi	6	dBmW	
Output Power	Po	36 (Note3)	dBmW	
Operating Case Temperature Range	T _{c (opr)}	-30~85	°C	
Storage Temperature Range	T _{stg}	-40~110	°C	

Type Name



Note1: This value is specified at no operation ($V_{GG} = 0 \text{ V}$, $P_i = \text{none}$)

Note2: This value is specified at no operation ($V_{DD} = 0 \text{ V}, P_i = \text{none}$)

Note3: This value is specified at no 50 Ω load operation

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ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent products specifications. Also, please keep in mind the precautions and conditions set forth in the TOSHIBA Semiconductor Reliability Handbook.

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Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition		Min	Тур.	Max	Unit
Frequency range	f _{range}	_		880	_	915	MHz
Leakage current	I _{leak}	V _{DD} = 6.0, V _{GG} = 0 V		_	500	_	μА
Output power	Po	$\begin{aligned} &P_i = 0 \text{ dBmW}, \text{ V}_{DD} = 3.6 \text{ V}, \text{ V}_{GG} \leqq 2.5 \text{ V} \\ &Z_G = Z_L = 50 \Omega \end{aligned}$		34.5	35.0	_	dBmW
Power gain	Gp			34.5	35.0	_	dB
Total efficiency (Note4)	Eff	$P_i = 0 \text{ dBmW}, V_{DD} = 3.6 \text{ V}, V_{GG} \le 2.5 \text{ V}$ $P_0 = 34.5 \text{ dBmW}, Z_G = Z_L = 50 \Omega$		37	43	_	%
Input VSWR	VSWR	$\begin{aligned} \text{P}_i &= \text{0 dBmW}, \text{V}_{DD} = 3.6 \text{V}, \text{V}_{GG} \leqq 2.5 \text{V} \\ \text{P}_0 &= 34.5 \text{dBmW}, \text{Z}_G = \text{Z}_L = 50 \Omega \end{aligned}$		_	_	3.0	_
Control current	I _{cont}				0.5	1.0	mA
2nd harmonics	2 nd HRM				-45	-35	dB
3rd harmonics	3 rd HRM				-50	-40	dB
Low voltage power	P _o -L	$\begin{aligned} P_i &= 0 \text{ dBmW}, \text{ V}_{DD} = 3.2 \text{ V}, \text{ V}_{GG} \leqq 2.5 \text{ V} \\ Z_G &= Z_L = 50 \Omega, \text{ T}_C = 85 ^{\circ}\text{C} \end{aligned}$		33.5	34.0	_	dBmW
Isolation	P _o -iso	P_i = 0 dBmW, V_{DD} = 3.6 V, V_{GG} = 0.3 V Z_G = Z_L = 50 Ω		_	-40	-37	dBmW
AM AM	0.04	$\begin{aligned} &P_{i1} = 0 \text{ dBmW}, \ P_{i2} = -40 \text{ dBmW} \\ &P_{in2} = P_{i1} + 200 \text{ kHz}, \ V_{DD} = 3.6 \text{ V} \\ &P_{0} = 7 \text{\sim} 34.5 \text{ dBmW} \ (V_{GG} = \text{adjust}) \\ &Z_{G} = Z_{L} = 50 \ \Omega \end{aligned}$	f0 – 200 kHz	_	-30	_	dB
AM-AM conversion	AM _{con}		f0 + 200 kHz	_	-30		dB
Switching time (Note5)	t _r /t _f	$V_{DD} = 3.6 \text{ V}$ $P_0 = 0 \sim 34.5 \text{ dBmW (V}_{GG} = \text{adjust)}$ $P_1 = 0 \text{ dBmW, } Z_G = Z_L = 50 \Omega$		_	1.0	_	μs
Noise Power NRB	f0 = 915 MHz, P _{in} = 0 dBmW	f0 + 20 MHz	_	-82	_	dBmW	
	NKB	P_0 = 34.5 dBmW, RBW = 100 kHz V_{DD} = 3.6 V, V_{GG} = adjust	f0 + 10 MHz	_	-78	_	dBmW
Load Mismatch	_	P_i = 0 dBmW, V_{DD} = 3.2~4.3 V P_o ≤ 34.5 dBmW (V_{GG} = adjust), Z_G = 50 Ω VSWR LOAD 6:1 ALL PHASE		No degradation		_	
Stability	_	$\begin{array}{l} P_i = 0 \text{ dBmW}, \text{ V}_{DD} = 3.2\text{-}4.3 \text{ V} \\ \text{V}_{GG} = 0\text{-}2.5 \text{ V}, \text{ Z}_{G} = 50 \Omega \\ P_0 \leqq 34.5 \text{ dBmW} \text{ (@Z}_L = 50 \Omega) \\ \text{VSWR LOAD 6:1 ALL PHASE} \end{array}$		All spurious output than 60 dB below desired signal			_

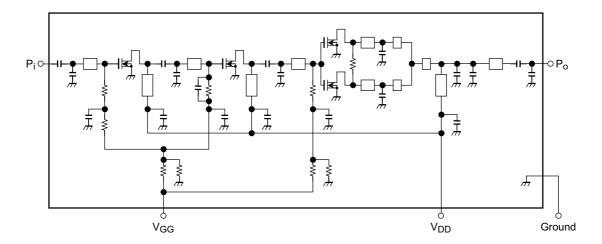
Note4: Output power Po is defined at the root point of the module output pin Po. The coefficient of output power loss in the P.C.B. output is showed as follows: $1/(S21)^2 = 1/(0.9809)^2 = 1.04$

Note5: GSM pulse is applied to V_{GG} (1/8 duty 575 μs)

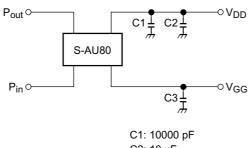
^{*:} This transistor is the electrostatic sensitive device. Please handle with caution.



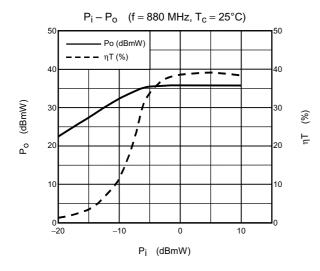
Schematic

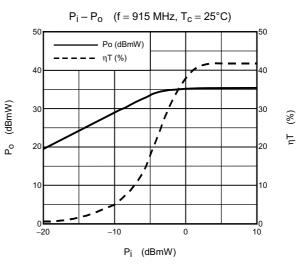


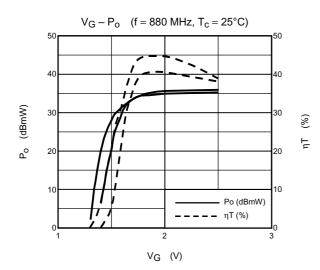
Test Circuit

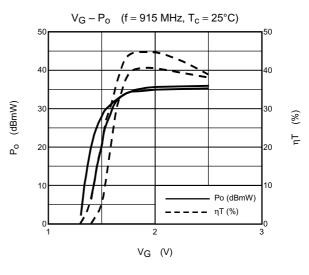


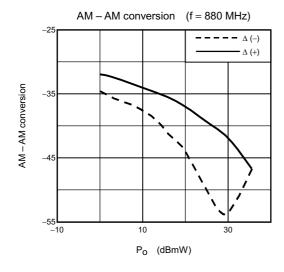
C2: 10 µF C3: 100 pF

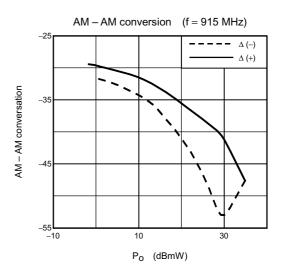












*: These are only typical curves and devices are not necessarily guaranteed at these curves.